## 2SC2647

## Silicon NPN epitaxial planar type

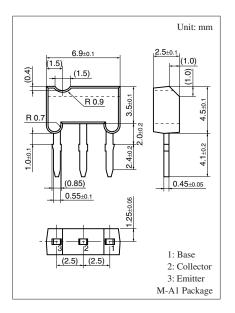
### For high-frequency amplification

#### ■ Features

- Optimum for RF amplification, oscillation, mixing, and IF of FM/AM radios
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board

## ■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter                             | Symbol           | Rating      | Unit |  |
|---------------------------------------|------------------|-------------|------|--|
| Collector-base voltage (Emitter open) | V <sub>CBO</sub> | 30          | V    |  |
| Collector-emitter voltage (Base open) | V <sub>CEO</sub> | 20          | V    |  |
| Emitter-base voltage (Collector open) | $V_{EBO}$        | 5           | V    |  |
| Collector current                     | $I_C$            | 30          | mA   |  |
| Collector power dissipation           | P <sub>C</sub>   | 400         | mW   |  |
| Junction temperature                  | $T_{j}$          | 150         | °C   |  |
| Storage temperature                   | $T_{stg}$        | -55 to +150 | °C   |  |



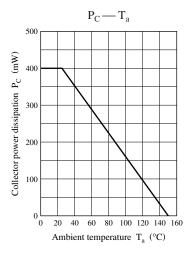
## ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

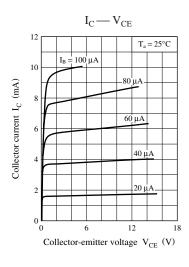
| Parameter                                   | Symbol           | Conditions   | Min | Тур | Max | Unit |
|---|------------------|--|-----|-----|-----|------|
| Collector-base voltage (Emitter open)       | V <sub>CBO</sub> | $I_C = 10 \ \mu A, I_E = 0$  | 30  |     |     | V    |
| Collector-emitter voltage (Base open)       | V <sub>CEO</sub> | $I_C = 2 \text{ mA}, I_B = 0$                                      | 20  |     |     | V    |
| Emitter-base voltage (Collector open)       | $V_{EBO}$        | $I_E = 10 \ \mu A, \ I_C = 0$                                      | 5   |     |     | V    |
| Forward current transfer ratio *            | $h_{FE}$         | $V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$                      | 70  |     | 250 | _    |
| Transition frequency                        | $f_T$            | $V_{CB} = 10 \text{ V}, I_E = -1 \text{ mA}, f = 200 \text{ MHz}$  | 150 | 230 |     | MHz  |
| Common-emitter reverse transfer capacitance | C <sub>re</sub>  | $V_{CB} = 10 \text{ V}, I_E = -1 \text{ mA}, f = 10.7 \text{ MHz}$ |     | 1.3 | 1.6 | pF   |
| Reverse transfer impedance                  | Z <sub>rb</sub>  | $V_{CB} = 10 \text{ V}, I_E = -1 \text{ mA}, f = 2 \text{ MHz}$    |     |     | 60  | Ω    |

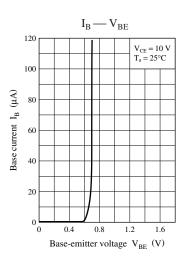
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

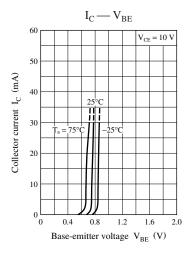
#### 2. \*: Rank classification

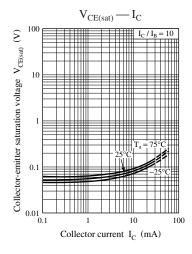
| Rank     | В         | С          |
|----------|-----------|------------|
| $h_{FE}$ | 70 to 160 | 110 to 250 |

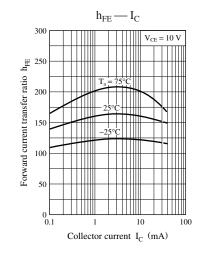


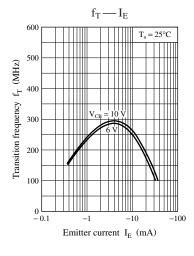


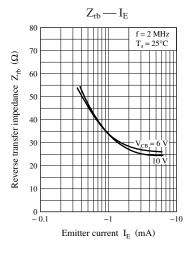


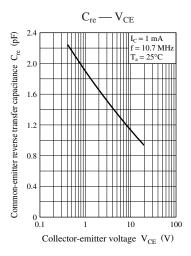


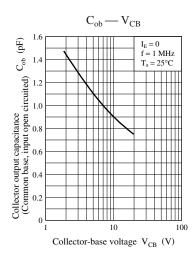


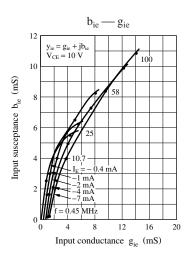


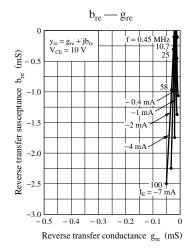


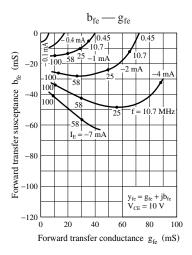


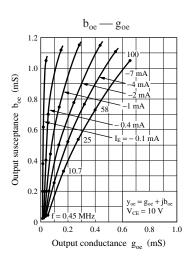












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